



Intel® Atom™ Processor C2758 (4M Cache, 2.40 GHz)

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Specifications

Essentials

Status	Launched
Launch Date	Q3'13
Processor Number	C2758
Cache	4 MB
Instruction Set	64-bit
Embedded Options Available	<input checked="" type="checkbox"/> Yes
Lithography	22 nm
Recommended Customer Price	

Performance

# of Cores	8
# of Threads	8
Processor Base Frequency	2.4 GHz
TDP	20 W

Memory Specifications

Max Memory Size (dependent on memory type)	64 GB
Memory Types	DDR3/DDR3L 1600
Max # of Memory Channels	2
Physical Address Extensions	36-bit
ECC Memory Supported †	<input checked="" type="checkbox"/> Yes

Expansion Options

PCI Express Revision	2
PCI Express Configurations †	x1, x2, x4, x8, x16
Max # of PCI Express Lanes	16

I/O Specifications

USB Revision	2
# of USB Ports	4
Total # of SATA Ports	6
Integrated LAN	4x1 or 4x2.5 GbE
UART	2 Interfaces
Max # of SATA 6.0 Gb/s Ports	2

Package Specifications

Package Size	34 mm x 28 mm
Sockets Supported	FCBGA1283
Low Halogen Options Available	See MDDS

Advanced Technologies

Intel® Turbo Boost Technology †	No
Intel® Hyper-Threading Technology †	<input checked="" type="checkbox"/> No
Intel® Virtualization Technology (VT-x) †	<input checked="" type="checkbox"/> Yes
Intel® VT-x with Extended Page Tables (EPT) †	<input checked="" type="checkbox"/> Yes
Intel® 64 †	<input checked="" type="checkbox"/> Yes
Intel® QuickAssist Technology	<input checked="" type="checkbox"/> Yes

Intel® Data Protection Technology

Intel® AES New Instructions	<input checked="" type="checkbox"/> Yes
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Intel® Platform Protection Technology

Execute Disable Bit †	<input checked="" type="checkbox"/> Yes
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Related Products

- Intel® Atom™ Processor for Communications
- Intel® Atom™ Processor C2000 Product Family for Communications
- Products formerly Rangeley

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PCN/MDDS Information

SR1CW
930451: PCN | MDDS

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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

† This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See <http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading> for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

The Recommended Customer Price ("RCP") is pricing guidance for Intel products. Prices are for direct Intel customers, typically represent 1,000-unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see <http://www.intel.com/performance>.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See <http://www.intel.com/content/www/us/en/processors/processor-numbers.html> for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

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